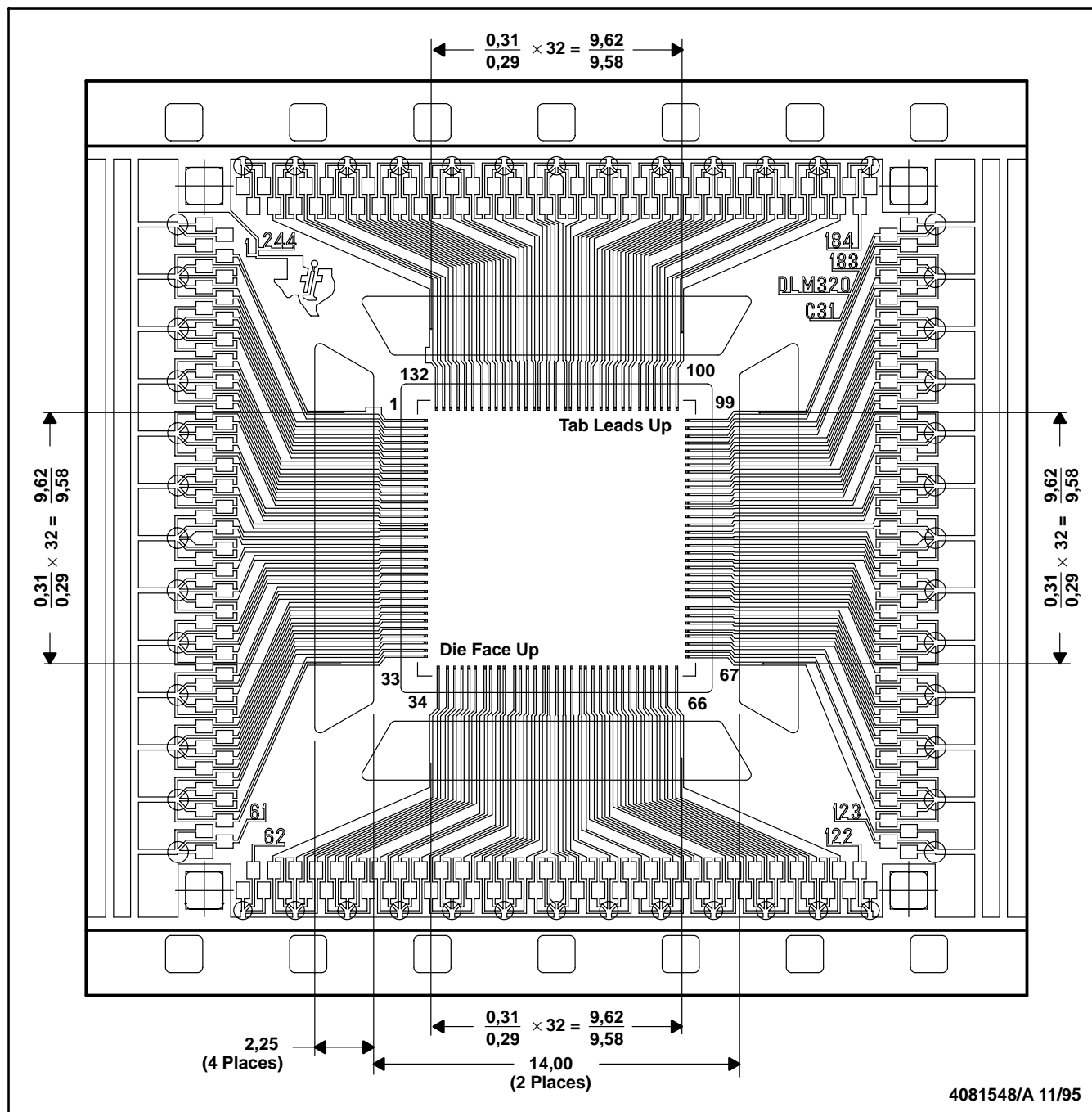


TA (S-MQCC-F132)
(35 OR 70 mm WITH PROTECTIVE FILM)

SMJ320C31 244-PIN TAB FRAME (PG2) SOCKET,
132 OLB/ILB 0,30-mm PITCH



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. The OLB lead width is $0,120 \pm 0,03$ mm.
D. The ILB lead width is $0,0832 \pm 0,015$ mm.
E. The tape width is 35 mm.
F. The TA is encapsulated die with polyimide overcoat.

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